ASSOCIATION CONNECTING ELECTROMICS INDUSTRIES® International and Pan-American co	ourn, Illinois, All rights reserved un	this docum der both level parts,	nent is a declaratio the declaration en	n of the substance compasses all low	es within the manufacture ver level materials for wh	er listed item. Note: i nich the manufacture	f the item is an as has engineering	sembly with lower responsibility.		
IPC Web Site for Information on I http://www.ipc.org/IPC-175x	PC-1752 Standard	Form Type * Distribute	Decla Class	o, Homogeneous Materia	als and Mfg Information	ion				
Supplier Information										
Company name*	Company unique ID		Unique ID Authority			Response Date*				
onsemi	ai							2023-06-08		
Contact Name	Title - Contact		Phone - Contact*			Email - Contact*				
Product-Env-Stewards	Product Enviro Compliance		NA			Product-Env-Stewards@onsemi.com				
Authorized Representative*	orized Representative* Title - Representative		Phone - Representative*			Email - Representative*				
Product-Env-Stewards Product Enviro Compliance			NA			Product-Env-Stewards@onsemi.com				
Requester Item Number Mfr Item	Number Mfr Item Name		Effective Date	Version	Manufacturing Site	Weight*	UOM	Unit Type		
FAN108	0M6X PSR PWM		2023-06-08		TAD	17.874	mg	Each		
Manufacturing Proccess Information										
Terminal Plating / Grid Array Material T	erminal Base Alloy J-	-STD-020 MSL Rating	Peak Process Body Temperature Max Time at		ure Max Time at Peak	k Temperature Number of Reflow Cycles				
Matte Tin (Sn) - annealed CU Alloy 1			260	С	30	seconds 3				
Comments										
evel 1 - maximum time at peak temperature during sol	dering is 10-30 seconds									
For more information regarding material composition	please refer to page 3									

RoHS Material Composition Declaration				Declaration Type *	Detailed			
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Disobutyl phthalate (DIBP).							
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of			
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted			
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all			
Exemption List Version	EL-2011/534/EU							
Declaration Signature								
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the			
Supplier Digital Signature Ra	stislav Drska	Le						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.779	mg	Supplier	Silicon (Si)	7440-21-3		0.779	mg
Die Attach 0.	0.099	mg	Supplier	Silver (Ag)	7440-22-4		0.0792	mg
			Supplier	Phenolic Resin-2	54208-63-8		0.0198	mg
Lead Frame 8	8.252	mg	Supplier	Silver (Ag)	7440-22-4		0.022	mg
			Supplier	Zinc (Zn)	7440-66-6		0.01	mg
			Supplier	Iron (Fe)	7439-89-6		0.198	mg
			Supplier	Copper (Cu)	7440-50-8		8.0201	mg
			Supplier	Phosphorus (P)	7723-14-0		0.002	mg
Mold Compound-Black	7.588	mg	Supplier	Ortho Cresol Novolac Resin	29690-82-2		1.9	mg
			Supplier	Carbon Black (C)	1333-86-4		0.038	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		5.65	mg
Plating	1.13	mg	Supplier	Tin (Sn)	7440-31-5		1.13	mg
Wire Bond - Au	0.026	mg	Supplier	Gold (Au)	7440-57-5		0.026	mg